Applicable												
Operating Temperature		e range	-55 °C to	to +105°C (Note1)		Storage Temperature range			-10 °C to +60°C (Note3)			
Rating	Operating Humidity ra	nge	20% to 80% (Note2) DF63-5S-3.96C			torage umidity ra	ange		40% to 70% (Note3)			
	Applicable Connector					Voltage			AC/DC 630V			
					С	Current			AWG16:12A AWG18:11A			
									AWG	20:9A A	WG22:	8A
			ed Voltage	Rated C			Overvolta	age Ca	tegory	IP-	Degree	
<u></u> I	JL,C-UL				oove							
TUV TUV		300	See al		н					IP00		
				Specifica	ations							
Constructi	Item		Test me	thod				Requ	irements		Q	AT
Constructi	kamination	Visually an	d by measuring in	strument		Accor	dina to dr	awina			Х	X
Marking	kamination	Visually and by measuring instrument. Confirmed visually.					According to drawing.					X
	aracteristics						L					^
Contact R		20mV MAX	, 1mA(DC or 1000	OHz).		10m (2 MAX.				X	_
	resistance	500 V DC.					1000 MΩ MIN.					
Voltage pr			1500 V AC for 1 min.				No flashover or breakdown.					_
	al characteristic											
			imes insertion and extraction.				(1) Contact resistance: $20m \Omega$ MAX.					_
							②No damage, crack or looseness of parts.					
Vibration		Frequency	Frequency 10 to 55 Hz, single amplitude				(I) No electrical discontinuity of 1µs.					_
			0.75 mm, at 10 cycles for 3 direction.				②No damage, crack or looseness of parts.					
Shock			490 m/s^2 duration of pulse 11 ms at 3 times each for				①No electrical discontinuity of 1µs.					_
			3 both axial directions.				2 No damage, crack or looseness of parts.					
	ental characteris					~						
Damp hea			Exposed at 40 \pm 2°C , 90 to 95 %, 96 h.				ntact resis				Х	-
(Steady st	ate)	(After leavin	(After leaving the room temperature for 1 to 2h.)				\bigcirc Insulation resistance: 500 MΩ MIN. \bigcirc No damage, crack or looseness of parts					
Danid ak-	ngo of						 ③No damage, crack or looseness of parts. ①Contact resistance: 20m Ω MAX. 					
Rapid cha temperatu		Time	Temperature -55°C \rightarrow +85°CTime30min \rightarrow 30min				() Contact resistance: $20m \Omega$ MAX. (2) Insulation resistance: $1000 M\Omega$ MIN.					_
emperatu		-	Under 5 cycles.				③No damage, crack or looseness of parts.					
		(The transferring time of the tank is 2 to 3 min)					erte damage, clast er leeceness er parte.					
		After leavin	ng the room tempe	erature for 1 to								
	e to soldering		1) Automatic soldering (Flow)				formatior			ssive	Х	-
heat		Soldered at solder temperature				looser	ness of th	e term	inals.			
			 260°C for immersing duration 10s. 2) Manual soldering Soldering iron tempreture: 300°C Soldering time: 3s 									
		'										
			ength on contact.									
Solderabil	ity		Soldered at solder temperature				uniform				Х	-
		245℃ for i	245° C for in immersing duration 5s.				cover minimum of 95% of the surface being immersed.					
Note 1: Ind	clude the tempe	erature rising h	oy current.			being	mmerse	u.				
Note 2: No	condensing	-	-									
Note3: Ap	ply to the condi	tion of long ter	m storage for unu	used products b	efore m	nounted o	n PCB.	ulue : t			-4'	
Afte	er mounted on F	PUB board , of	perating temperate	ure and humidit	y range	e is applie	ea tor inte	rim sto	rage durir	ig transport	ation.	
Co	unt	Description	n of revisions	evisions Designed Checked		ked	Г	Date				
<u>A</u>							.9					
2		DIS-H-	00004228	TS. KUM		UMAZAW	MAZAWA		SZ. ONO		18.	09.2
Domerter												0
Remarks							Approved					07.13
							Checked		TS. F	UKUSHIMA		
							Designed		YK. Y			07.12
Unless of	erwise specifie	ed, reter to IEC	C 60512.				Drawn				07.12	
Note QT	Qualification T	est AT:Assu	st AT:Assurance Test X:Applicable Test				ng No.	ELC-365877-00-00				
LDC		Specification sheet				art No.		Г	DF63-3P-7.92DS			
		•										1/1
			ROSE ELECTRIC CO., LTD. Co				ode No. CL68			80-0559-0-00 🔬 1/		

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